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**Universal serial bus interfaces for data and power –
Part 1-3: Common components – USB Type-C® Cable and Connector
Specification**

**Interfaces de bus universel en série pour les données et l'alimentation
électrique –
Partie 1-3: Composants communs – Spécification des câbles et connecteurs
USB Type-C®**



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USB Type-C®**

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UNIVERSAL SERIAL BUS INTERFACES FOR DATA AND POWER

Part 1-3: Common components – USB Type-C® Cable and Connector Specification

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CDV	Report on voting
100/3439/CDV	100/3501/RVC

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